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Deborah W. Wenocur
Deborah W. Wenocur

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Applicant: K. Sahota, D. Schonauer, J. Groschopf,)
G. Marxsen, and S. Avanzino,) Grp Art Unit: 1765
Assignee: Advanced Micro Devices, Inc.) Exam: L. Umez Eronini
Serial Number: 09/749,191)
Filed: December 26, 2000)
For: PREVENTION OF PRECIPITATION)
DEFECTS ON COPPER INTER-)
CONNECTS DURING CMP BY USE)
OF SOLUTIONS CONTAINING)
ORGANIC COMPOUNDS WITH)
SILICA ADSORPTION AND COPPER)
CORROSION INHIBITING)
PROPERTIES)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REQUEST FOR RECONSIDERATION AND
REQUEST TO WITHDRAW THE FINAL REJECTION

Dear Sir,

This is in response to the Office Action mailed on July 22, 2003. Applicant notes that this reply falls within the two month period for timely Advisory Action. Applicant respectfully requests that the arguments herein be fully considered.